

MOSFET

600V CoolMOS™ SJ S7 Power Device

IPT60T022S7 enables the best price performance for low-frequency switching applications. CoolMOS™ S7 boasts the lowest Rdson values for an HV SJ MOSFET, with a distinctive increase in energy efficiency. The embedded Temperature sensor increases junction temperature sensing accuracy and robustness while keeping an easy and seamless implementation. CoolMOS™ S7 is optimized for "static switching" and high current applications. It is an ideal fit for solid-state relay, circuit breaker designs, and line rectification in SMPS and inverter topologies. The new temperature sensor enhances S7 features, allowing the best possible utilization of the power transistor.



Features

- CoolMOS $^{\text{TM}}$ S7 technology enables lowest $R_{\text{DS(on)}}$ in the smallest footprint
- Optimized price performance in low-frequency switching applications
- · High pulse current capability
- Seamless diagnostics at the lowest system
- Temperature sense feature for protection and optimized thermal device utilization cost

Benefits

- Minimized conduction losses (eliminate/reduce heat sink)
- Increased system performance
- More compact and more straightforward design
- Lower BOM or/and TCO over a prolonged lifetime
- Reduction of external sensing elements

Compared to electromechanical devices:

- Faster switching times
- More reliability and longer system lifetime
- Shock & Vibration resistance
- · No contact arcing or bouncing

Potential applications

- · Solid state relays and circuit breakers
- Line rectification in high power/performance applications e.g. Computing, Telecom, UPS and Solar

Product validation

Fully qualified according to JEDEC for Industrial Applications



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Parameter	Value	Unit					
R _{DS(on),max}	40	mΩ					
$Q_{g,typ}$	83	nC					
V _{SD}	0.82	V					
Pulsed I _{SD} , I _{DS}	203	A					
ESD class (HBM)	2	JEDEC JS-001					

Type / Ordering Code	Package	Marking	Related Links
IPT60T040S7	PG-HSOF-8	60I040S7	see Appendix A

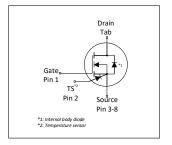










Table of Contents

scription	1
ximum ratings	. 3
ermal characteristics	4
ectrical characteristics	. 5
mperature Sensor parameters	7
ectrical characteristics diagrams	
st Circuits	13
ckage Outlines	14
pendix A	15
vision History	16
ademarks	16
sclaimer	16



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum MOSFET ratings**

Parameter	Cumbal		Value	s		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain current rating ¹⁾	I _D	-	-	13	A	T _C =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability
Pulsed drain current ²⁾	I _{D,pulse}	-	-	203	Α	T _C =25°C
Avalanche energy, single pulse	E _{AS}	-	-	156	mJ	I _D =2.7A; V _{DD} =50V; see table 11
Avalanche current, single pulse	I _{AS}	-	-	2.7	Α	-
MOSFET dv/dt ruggedness ³⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	245	W	<i>T</i> _C =25°C
Storage temperature	T _{stg}	-55	-	150	°C	-
Operating junction temperature ¹⁾	T _j	-55	-	150	°C	-
Extended operating junction temperature	T _j	150	-	175	°C	≤50 h in the application lifetime
Mounting torque	-	-	-	n.a.	Ncm	-
Diode forward current rating	Is	-	-	13	А	T_C =25°C Current is limited by $T_{j max}$ = 150°C
Diode pulse current ¹⁾	I _{S,pulse}	-	-	203	Α	T _C =25°C
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=13A, $T_{\rm j}$ =25°C see table 9
Maximum diode commutation speed	di _f /dt	-	-	800	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=13A, $T_{\rm j}$ =25°C see table 9
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	-

 $^{^{1)}}$ Please consider the App Note: AN_2308_PL52_2309_111546 for high delta $T_{\rm J}$ usage $^{2)}$ Pulse width t_p limited by $T_{\rm j,max}$ $^{3)}$ The dv/dt has to be limited by appropriate gate resistor $^{4)}$ Identical low side and high side switch



2 Thermal characteristics

Table 3 Thermal characteristics

Damamatan	Ob. a.l	Values			11	Nata / Tank One little
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.51	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	$R_{ m thJA}$	-	35	45	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling.
Soldering temperature, wave- & reflow soldering allowed	T _{sold}	-	-	260	°C	reflow MSL1



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage >420V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Domonoston	Oh a l		Values			Nata / Tank Oans Hittan
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V _{GS} =0V, I _D =1mA
Gate threshold voltage	$V_{\rm (GS)th}$	3.5	4	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 0.78 {\rm mA}$
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 20	2 -	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.036 0.084	0.040	Ω	V _{GS} =12V, I _D =13.0A, T _j =25°C V _{GS} =12V, I _D =13.0A, T _j =150°C
Gate resistance	R _G	-	0.8	-	Ω	f=1MHz, open drain

Table 5 **Dynamic characteristics**

Davamatan	Cumahal	Values			11!4	Nata / Tank Oncollision
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	3128	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz
Output capacitance	Coss	-	50	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	168	-	pF	V _{GS} =0V, V _{DS} =0 to 300V
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	1476	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0 to 300V
Output charge	Qoss	-	443	-	nC	V _{GS} =0V, V _{DS} =0 to 300V
Turn-on delay time	$t_{\sf d(on)}$	-	18	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.0A, $R_{\rm G}$ =8.0 Ω ; see table 9
Rise time	t _r	-	12	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.0A, $R_{\rm G}$ =8.0 Ω ; see table 9
Turn-off delay time	$t_{\sf d(off)}$	-	120	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.0A, $R_{\rm G}$ =8.0 Ω ; see table 9
Fall time	t _f	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.0A, $R_{\rm G}$ =8.0 Ω ; see table 9

²⁾ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V



Table 6 Gate charge characteristics

Dougnatou	Cumbal	Values			11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	17	-	nC	V_{DD} =300V, I_{D} =13.0A, V_{GS} =0 to 12V
Gate to drain charge	Q _{gd}	-	27	-	nC	V_{DD} =300V, I_{D} =13.0A, V_{GS} =0 to 12V
Gate charge total	Qg	-	83	-	nC	V_{DD} =300V, I_{D} =13.0A, V_{GS} =0 to 12V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	V_{DD} =300V, I_{D} =13.0A, V_{GS} =0 to 12V

Table 7 Reverse diode characteristics

Paramatan.	Or made al	Values			11	Nata / Tant Can dition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.82	-	V	V _{GS} =0V, I _F =13.0A, T _j =25°C
Reverse recovery time	t _{rr}	-	360	-	ns	V_R =400V, I_F =13.0A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	5.50	-	μC	V_R =400V, I_F =13.0A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	32.0	-	А	V_R =400V, I_F =13.0A, di_F/dt =100A/ μ s; see table 8



4 Temperature Sensor parameters at T_j =25°C, unless otherwise specified

Table 8 **Maximum ratings**

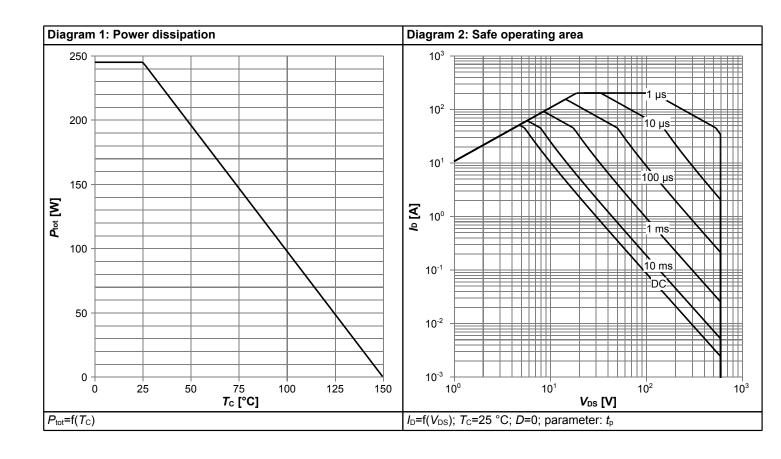
Pagamatan	0		Value	s	l lmi4	Note / To at O and Hitler
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Repetitive Peak Reverse Voltage	V_{RRM}	-	-	15	V	<i>I</i> _R = 100 μA
Sensor forward current	I _F	-	-	5	mA	-
Repetitive peak forward current	I _{F_pulse}	_	-	25	mA	t _{pulse} = 1 ms, T _{period} = 10 ms
Non-repetitive peak forward current	I _{FSM}	- - -	-	1.5 0.2 0.1	A	$T_{C} = 25^{\circ}\text{C}, t_{\text{pulse}} = 1 \mu\text{s}$ $T_{C} = 25^{\circ}\text{C}, t_{\text{pulse}} = 1 m\text{s}$ $T_{C} = 25^{\circ}\text{C}, t_{\text{pulse}} = 1 \text{s}$
Junction Temperature	T _j	_	-	185	°C	t < 50h, Sensor only

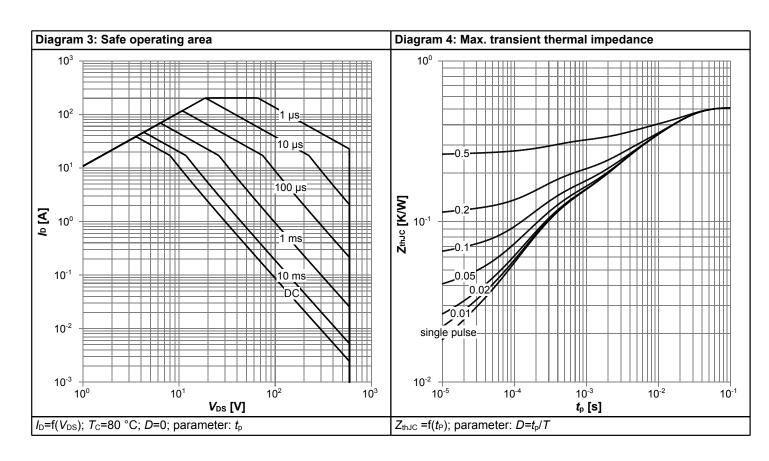
Table 9 **Electrical characteristics**

Damana da m	Ol		Values			N 4 7 4 0 100
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Sensor forward voltage ¹⁾	V _{F_25}	1.5601 - - 2.0665	1.6019 1.8103 1.9806 2.0966	-	V	$T_{j} = 25^{\circ}C$, $I_{F} = 10 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 50 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 200 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 500 \mu A$
Sensor forward voltage temperature coefficient	TC	- - - -	5.9644 5.5880 5.2287 5.0135	-	mV/K	$\begin{array}{c} 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 10 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 50 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 200 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 500 \; \mu A \end{array}$
Sensor forward voltage	V _{F_175}	-	0.7072 0.9721 1.1963 1.3445	-	V	$T_{j} = 175^{\circ}\text{C}, \ I_{F} = 10 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 50 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 200 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 500 \ \mu\text{A}$
Reverse leakage current	I_{R}	-	-	1 20	μA	$V_R = 10V, T_j = 25^{\circ}C$ $V_R = 10V, T_j = 175^{\circ}C$
Sensor G Capacitance	C _{GTS}	-	4.2	-	pF	f = 1 MHz, I _F = 50 μA
Sensor Capacitance	C _{STS}	-	4.8	-	pF	f = 1 MHz, I _F = 50 μA
Anode-Drain Capacitance	C _{DTS}	-	0.5	-	pF	f = 1 MHz, V _{DS} = 0 V

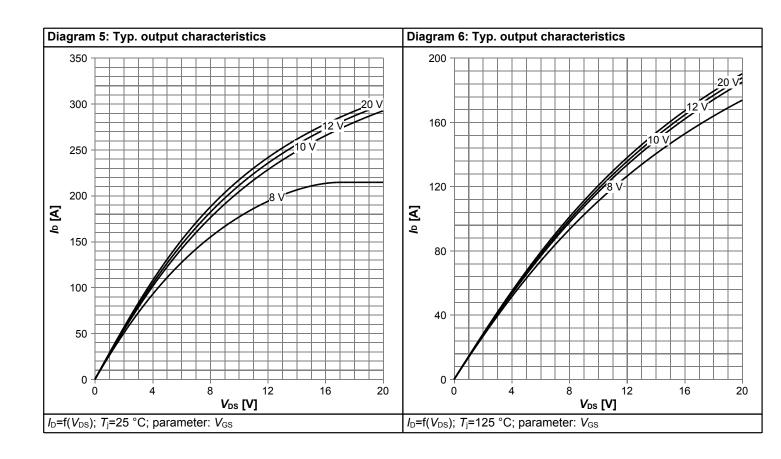


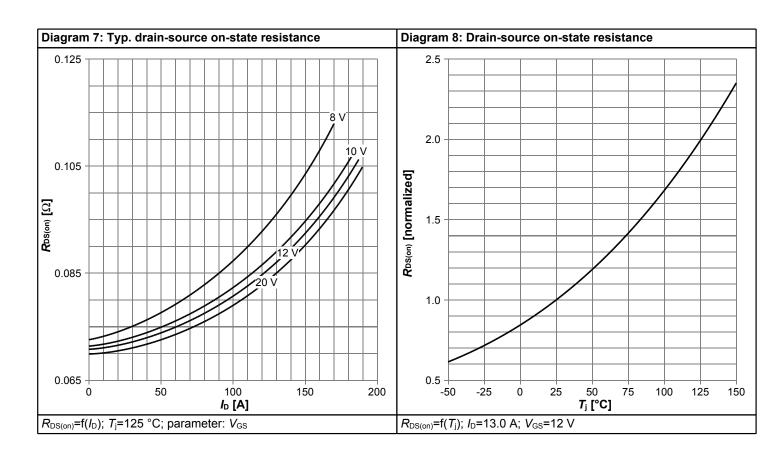
5 Electrical characteristics diagrams



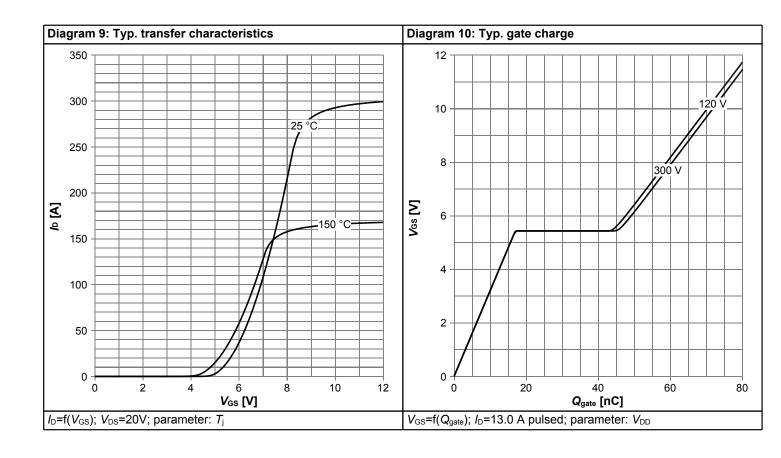


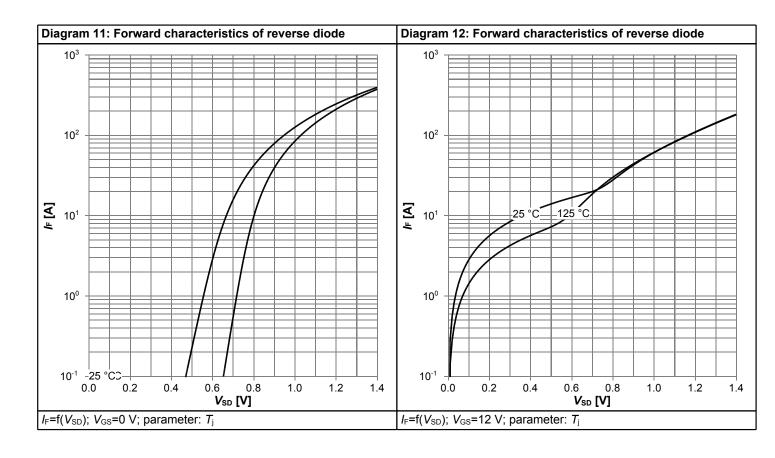




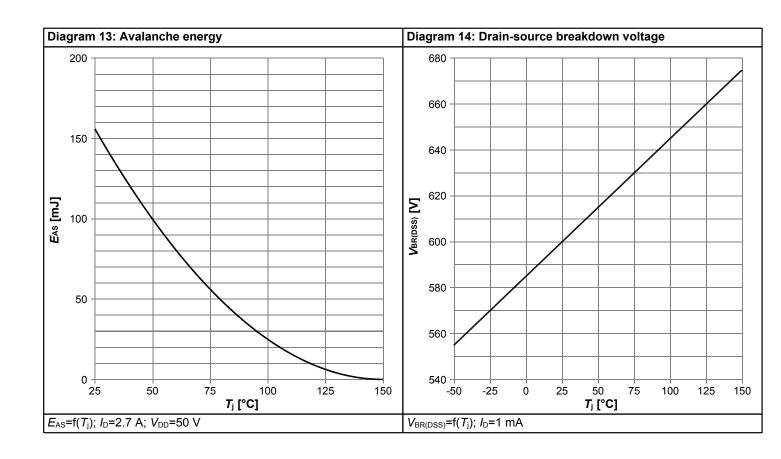


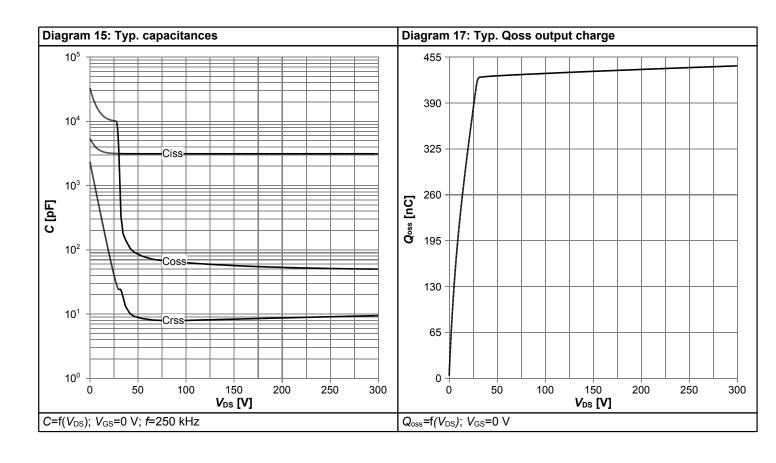




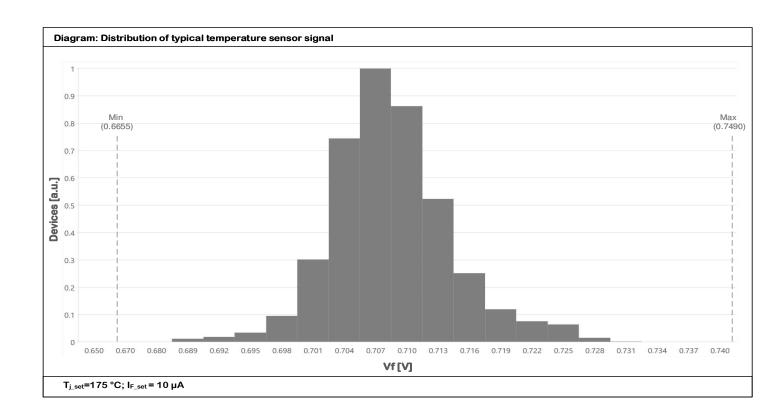














6 Test Circuits

Table 10 Diode characteristics

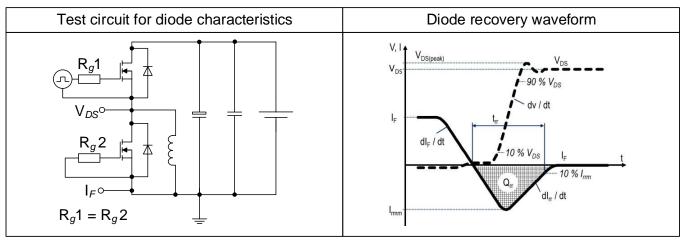


Table 11 Switching times (ss)

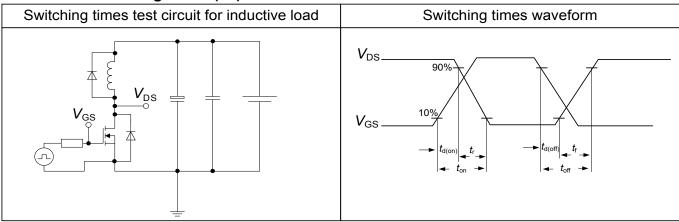
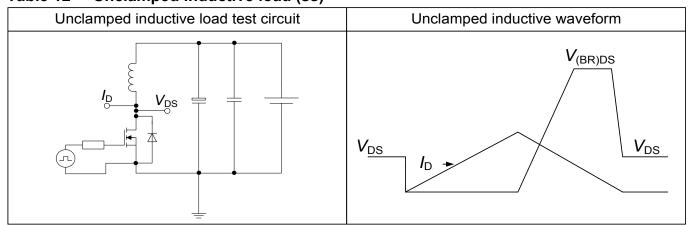
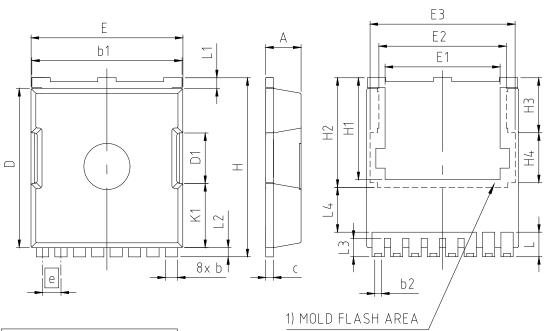


Table 12 Unclamped inductive load (ss)





7 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HSOF-8-U02						
DIMENSIONS	MILLIMETERS						
DIMENSIONS	MIN.	MAX.					
Α	2.20	2.40					
b	0.70	0.90					
b1	9.70	9.90					
b2	0.42	0.50					
С	0.40	0.60					
D	10.28	10.58					
D1	3.30						
E	9.70	10.10					
E1	7.50						
E2	8.50						
E3	9.46						
е	1.20 (BSC)						
Н	11.48	11.88					
H1	6.55	6.95					
H2	7	.15					
Н3	3	.59					
H4	3.26						
N	8						
K1	4.18						
L	1.40 1.80						
L1	0.50	0.90					
L2	0.50	0.70					
L3	1.00	1.30					
L4	2.62 2.81						

1) PARTIALLY COVERED WITH MOLD FLASH

Figure 1 Outline PG-HSOF-8, dimensions in mm



8 Appendix A

Table 13 Related Links

• IFX CoolMOS S7T Webpage: www.infineon.com

• IFX CoolMOS S7T application note: www.infineon.com

• IFX CoolMOS S7T simulation model: www.infineon.com

• IFX Design tools: www.infineon.com



Revision History

IPT60T040S7

Revision: 2023-09-25, Rev. 2.1

Provious Povision

FIEVIOUS REVISION		
Revision	Date	Subjects (major changes since last revision)
2.0	2023-09-18	Release of final version
2.1	2023-09-25	Drain current – change of test condition

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